**Development of Bioelectronic Scaffolds for Hybrid Brain Tissue**

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**ABSTRACT**

Bioelectric sensors are a popular tool for quickly assessing cellular physiologic status and metabolic changes. They have the ability to record real-time electrophysiology of active tissue - which can then be used to characterize action potentials and cellular networks. The Timko Lab has previously proposed and designed a flexible 3D bioelectronic scaffold multielectrode array (BioES) meant to be embedded with neural cells. When embedded within the hybrid engineered tissue scaffolds, these bioelectronic devices could provide stable, long-term readouts of tissue function. Within this two-team project, our research aims to develop and characterize the hybrid tissue scaffold environment and confirm the biocompatibility of the hybrid brain model and the bioelectronic device by embedding the bioelectronic device into the hybrid brain model. This type of integration has not previously been achieved and verifying this possibility could open a new range of possibilities for the field of bioengineering.

*This project is adapted from Megan A. Cote’s thesis submitted for a Master of Science in BME*1

**Key Words:** bioelectronics, brain model, silk scaffolds

**ENGINEERING DESIGN**

The project's overall objective and the end goal is to embed a bioelectronic device into a 3D brain tissue model. We plan for the human-induced neuronal stem cells (hiNSCs) to grow in a porous silk scaffold and to integrate a flexible 3D bioelectric scaffold multielectrode array (BioES) to form a hybrid brain model. Once this is accomplished, we expect to be able to measure neural activity. Successful integration means that it may be possible for researchers to monitor the electric signals in live organoids, specifically those modeling brain and cardiac tissue. The use of these bioelectronic chips will allow for the creation and verification of more representative models.

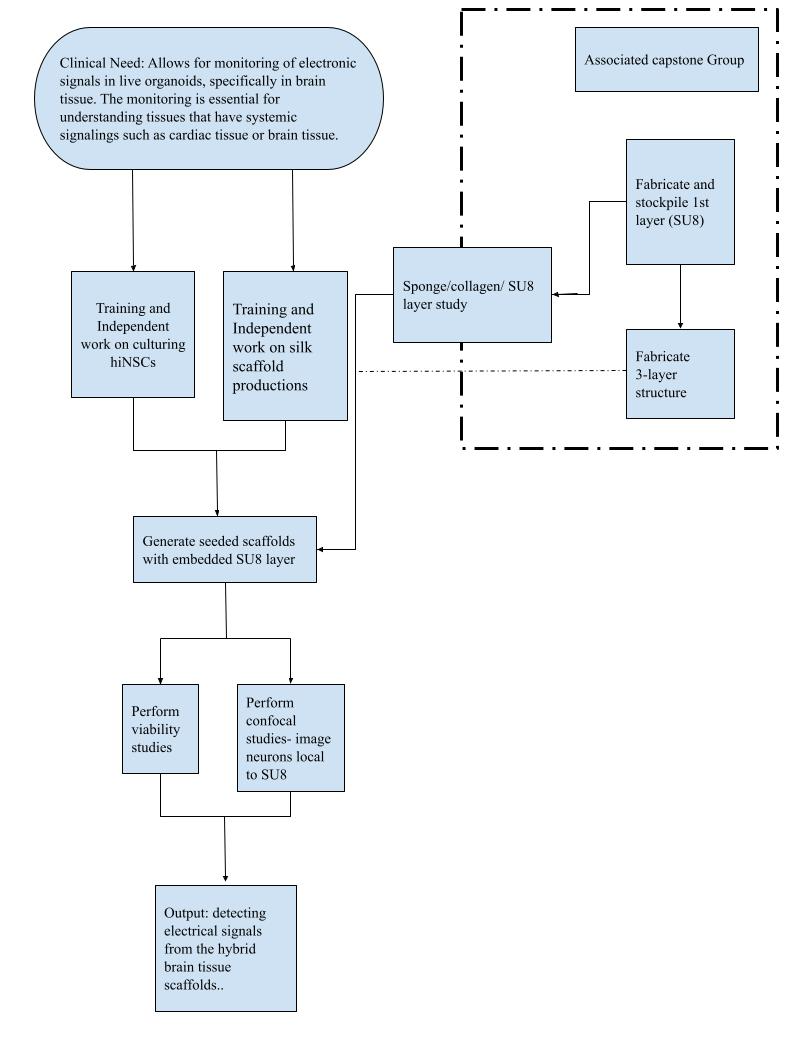
Our first objective is to integrate the top SU-8 layer of the BioES into the empty silk scaffold using an adhesive. The SU-8 has inert electrical properties and high compatibility with cells. The larger two electrodes just serve as ground references for the system which is why initial studies will focus on integrating just the SU8 layer. Next, we will assess structural integrity and compatibility between the empty silk scaffold (no hiNSCs), the SU-8 layer, and the surgical adhesive by looking for deterioration over time and its reaction to tensile stress. Our next objective would be to generate hiNSC seeded scaffolds with an embedded SU-8 layer and conduct viability assays of the cells to ensure long term survival within the silk scaffolds and device. We also plan on immunostaining our samples to visualize neural cells in the silk environment. We want to conduct metabolic calcium fluorescence assays to ensure spontaneous neural activity. Our final objective for this semester is to perform confocal studies to image neurons and activity on the SU-8 layer. Successful integration will signify a sound basis to move forward with the 3-layer BioES device.

From there we want to move forward with integrating the brain model with the completed 3-layer BioES. We want to perform viability studies - starting with live-dead assays for cell survival within the device. We are still exploring which methods and will optimize as we move forward. As of now, we will be using soldering to connect the bioelectronic device to the PCP board to measure the voltage of the neurons. We will use Kwik-Cast Silicone Elastomer as an adhesive to connect our seeded silk scaffolds to the BioES and the SU-8. These plans are subject to change as we continue with this project and assess durability/stability.

We expect there to be issues, especially regarding the travel between the Clean Rooms where the device is constructed, and the cell culture labs where the brain model will be developed. This could bring up issues with sterility. A clear and detailed protocol will be developed for sterilizing both our scaffolds and our device before implementation and maintaining that sterile environment once they are both in the Sci-Tech labs.

There may also be issues regarding the cell density which we seed since we are planning on sandwiching the BioES between 2 pieces of seeded silk scaffolds rather than cutting one scaffold in half. In addition, we want to ensure there are enough cells in contact with the device interface. For this, we plan on having multiple sets of empty scaffolds ready if we find that we need to increase our seeding density. As of now, we are moving forward using the standard seeding protocol used in the Kaplan Lab.

**DESIGN FLOW CHART**

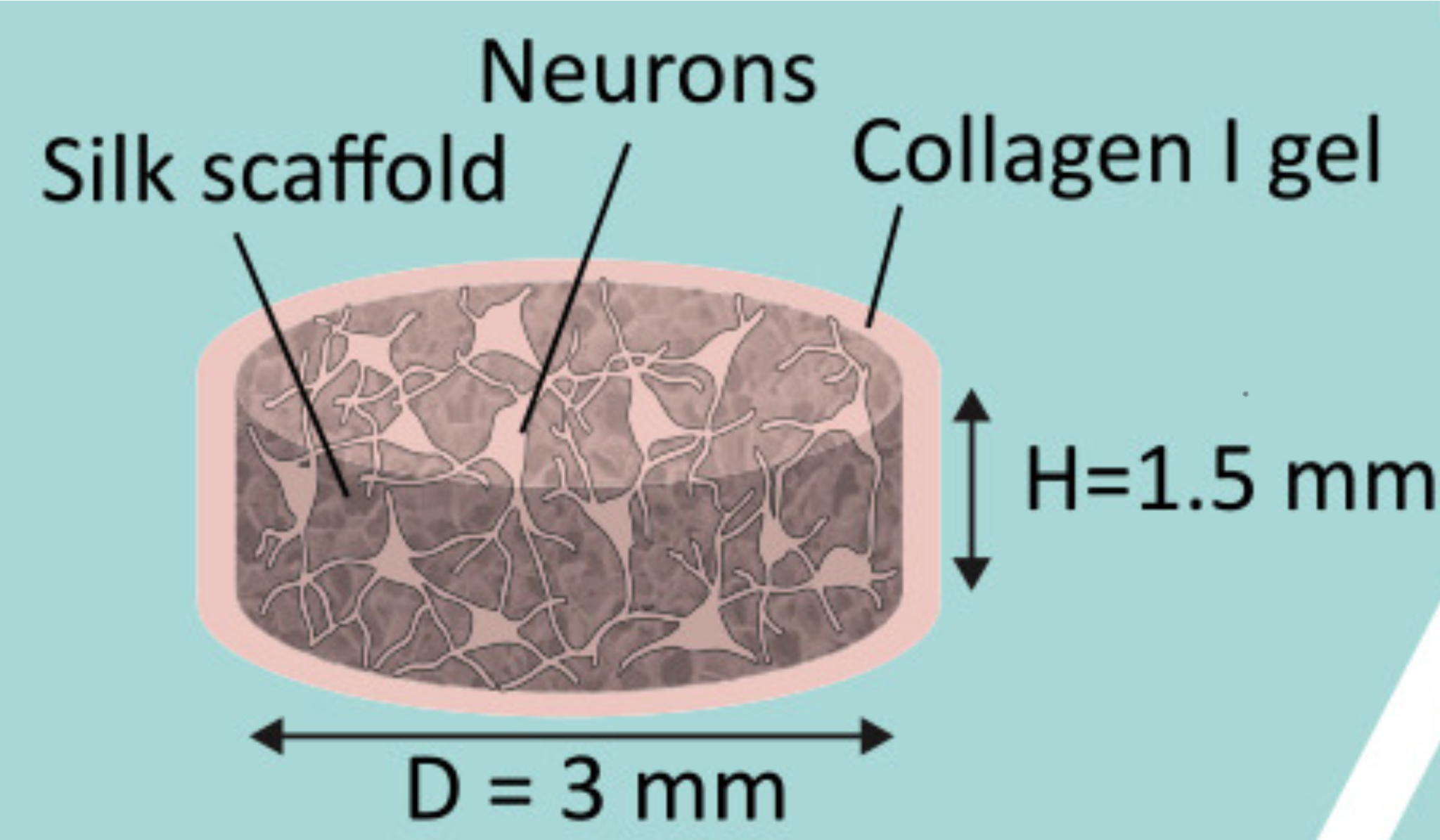
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**FIGURE 1.** The design flow chart of our project shows the main objectives and goals of the current project as well as the ultimate endpoint for this semester. Arrows demonstrate intended progress.

**INTRODUCTION & BACKGROUND**

Bioelectronics as stated in the name combines biology with electronics. With recent advancements, there is a promise that bioelectronics can be used to understand tissues that rely on electric signaling to lead their function. Along with an understanding of the tissues a better understanding of diseases that affect these tissues can also be developed. Currently, methods of understanding electrophysiology are invasive and complicated such as patch clamp assays or they lack temporal resolution such as Calcium Fluorescence imaging2,3.

We believe that a hybrid tissue, which is an organoid embedded with a bioelectronic could address this gap in knowledge. We are specifically interested in using this for neurons and brain tissue generally. The Kaplan Lab has already established a brain model using neurons and silk fibroin as a scaffold4–6. The organoids serve as a 3D functional model of the brain that can spontaneously fire, they also can alter the compositions of the scaffold to model a selection of disease states associated with neurons and brain tissues5. The scaffold shown in figure 3 has the exact dimensions and components as those used in this method the only difference is that the scaffolds used in the hybrid tissue have an additional hole in the middle making a donut shape to allow for a representation of grey matter to be the silk section and the hole to be the white matter section of the tissue model.

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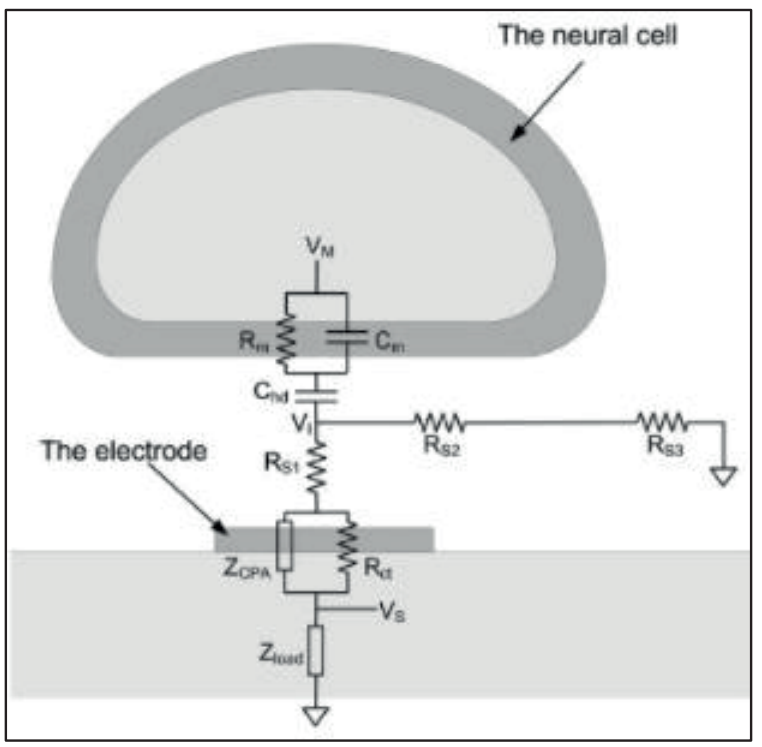
**Figure 2 Model of the Brain Tissue.** Shows the dimensions and important components of the 3D functional tissue model5.

The bioelectronic sensor we plan to use for our projects is a flexible scaffold that is designed to interface with neural cells. The sensors record real-time electrophysiology of electric active tissue. These readings allow us to characterize action potentials and cellular networks. Additionally, we can monitor ion channel states, and evaluate neural pathways. Specifically, the sensor is attached to a multielectrode array that was designed in the Timko Lab1. The multi-electrode array is rigid so it will not contour to the tissue meanwhile the sensor is flexible to allow for it to integrate with the active tissue, promoting cell-to-cell communications. Our main focus is the integration of the hybrid brain model. To ensure that the device could interface with cells they coated the microelectrode array with SU8 on the top and bottom, shown in a piece breakdown in figure 4. The reason why SU8 was selected as passivation is that it is biocompatible, inert, and compatible with cells1,7. Gold was chosen as the metal for electronics because of its malleability as well as its low toxicity1.

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**Figure 3 Schematic of Layers of the bioelectronic device.** Light blue layers represent SU8+ and the middle layer represents gold electrodes.

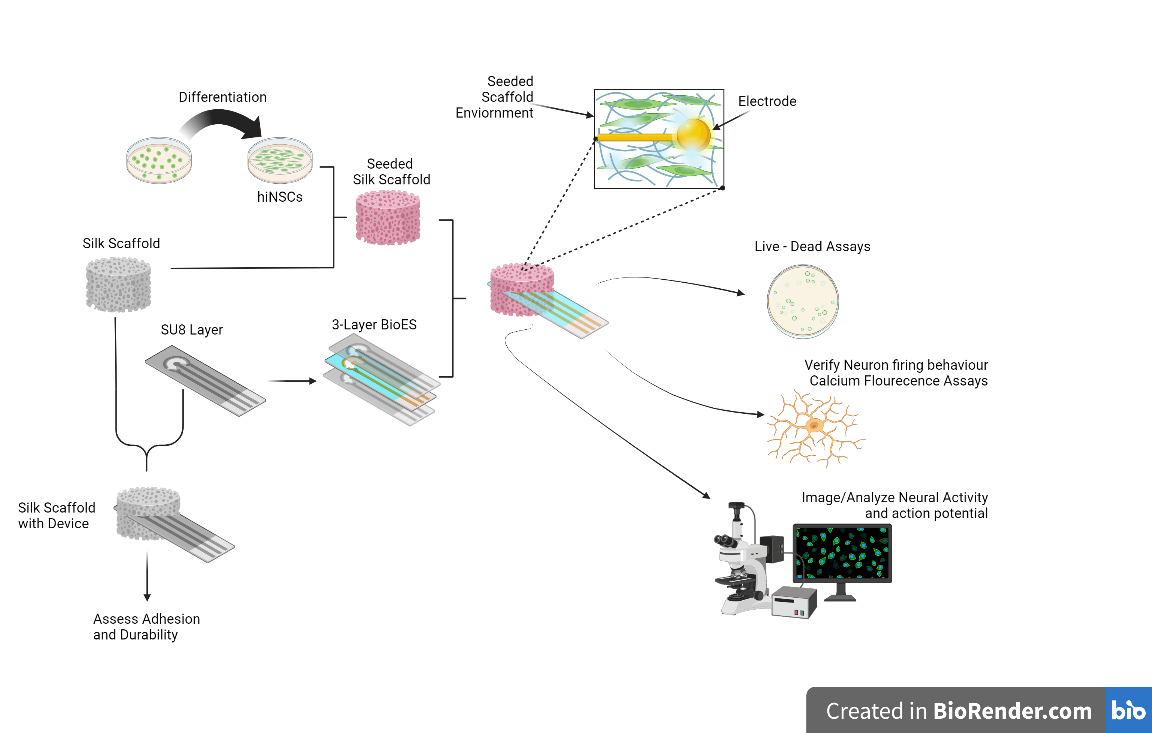
Separately the brain model and the flexible electronic innovations are well-known and researched however it's unknown how these would work together jointly. We expect that sandwiching the scaffold around the sensors would allow for the growth of neurons around the sensors, which would allow for integration. To successfully create the model hiNSCs are differentiated and then seeded on the silk scaffold. Once the neurons are in the scaffold their axons grow toward the center to communicate with one another. In Figure 5 we see an example of how the bioelectronic electrodes and the neurons will interface. This will create a circuit that can output electrical impulse readings on the surface and interior of the neurons.

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**Figure 4 The Interface of the Bioelectronic and the Neurons.** *Adapted from Joye, Neil, et al*8*.*

By taking these reading forms for prolonged periods of time it will hopefully give insight into how diseases function. It will provide information about systemic signaling, and once this platform is well established it can be applied to other tissues which rely heavily on systemic and spontaneous electrical signaling.

**UNIFYING FIGURE**

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**FIGURE 5.** This graphical summary outlines the experimental steps of the project beginning with cell differentiation and device compatibility assays and finishing with the end goal of assessing how successful the device is at detecting action potentials and neuron behavior.

**SPECIFIC AIMS**

***Aim 1: Evaluate Biocompatibility between polymer passivation SU8 layers, silk scaffold, and adhesive***

*1.1:* *Assess structural integrity and compatibility of empty silk scaffold and SU-8 top layer.* The goal of this sub-aim is to verify the ability of our proposed integration model to maintain structure and integrity while in use prior to adding any hiNSCs. Structural integrity is an important foundational step to ensure our brain model and device are compatible and stable for future experiments. This step is also important for determining if our adhesive can hold the structure together. We will generate silk collagen scaffolds with no seeded hiNSCs and adhere the scaffolds to the electrode end of the SU8 device using Kwik-Cast Silicone Elastomer. We will observe the model’s degradation over multiple hours, and we will observe its ability to maintain structural integrity when it’s touched/moved. This will aid in verifying our current design model. Success will be measured by us observing no deterioration in our scaffolds or glue after 24 hours.

*1.2: Characterize in vitro Brain Model.* Prior to full integration with the BioES, we must first be able to identify the distinct nature of the brain model environment within the silk scaffold. This aim will also help us better visualize cell clustering. As we mentioned within the Design Elements section, a problem we expect to encounter involves the seeding density of the hiNSCs. There needs to be enough cells near the top layer of the scaffold which will be in contact with the SU-8 and BioES for them to receive signaling information. Within this aim, we will be able to characterize the brain model and the growth behavior of the hiNCSs. Here hiNSCs will be thawed and differentiated as per Kaplan lab protocol. Once differentiated, they will be seeded onto the silk scaffolds with a collagen gel mixture and allowed to grow within the scaffold overnight. We will conduct live-dead assays to assess cell viability within the hybrid scaffold, immunostaining of scaffold sections to visualize neural cells within the silk environment, and metabolic calcium fluorescence assays to verify spontaneous neural activity as spontaneous activity is essential for obtaining readouts from the complete 3-layer BioES device. If we aren’t able to characterize a solid value goal for our calcium assays, we could also stain our samples for common neuralderm markers or conduct quantitative PCR (qRT-PCR) to analyze the expression of genes known to change during neural development, although both these alternatives are still being researched.

*1.3:* *Embed the SU-8 layer of the BioES into the in vitro brain model*. This will work in the same way as Aim 1.1 except the scaffold will no longer be empty. The Brain model part will be kept in a petri dish with cell culture media to keep neurons alive and viable. Cell viability will be assessed within this new complex environment using live-dead assays to ensure cell long term survival within our setup. This will help us finalize the biocompatibility and viability between all the interacting parts of our devices and scaffolds to ensure they will survive when fully integrated in Aim 2. Success will be if we observe >80% cell viability, otherwise, we may have to revisit our cell culture or our design plans. We will also perform confocal studies on the hybrid device to image neural cells local to the SU8 device to characterize, visualize and assess their behavior/happiness.

***Aim 2 (Future): Generate Seeded Scaffolds with an embedded 3-layer BioES***

Here we will repeat the plans described in Aim 1.3 but now we will utilize the completed 3-layer BioES device. The exposed end of the BioES device which is not connected to the seeded brain model will then be soldered onto the PCP board to begin measuring neuron voltage output and spontaneous electrical signals. More planning and research are being done to determine success outputs.



**FIGURE 6.** Completed hybrid brain model assembly plan - *as adapted from Megan A. Cote*1

**METHODS**

Note that these methods and protocols are subject to change as we move along this project. Changes will be clarified and justified.

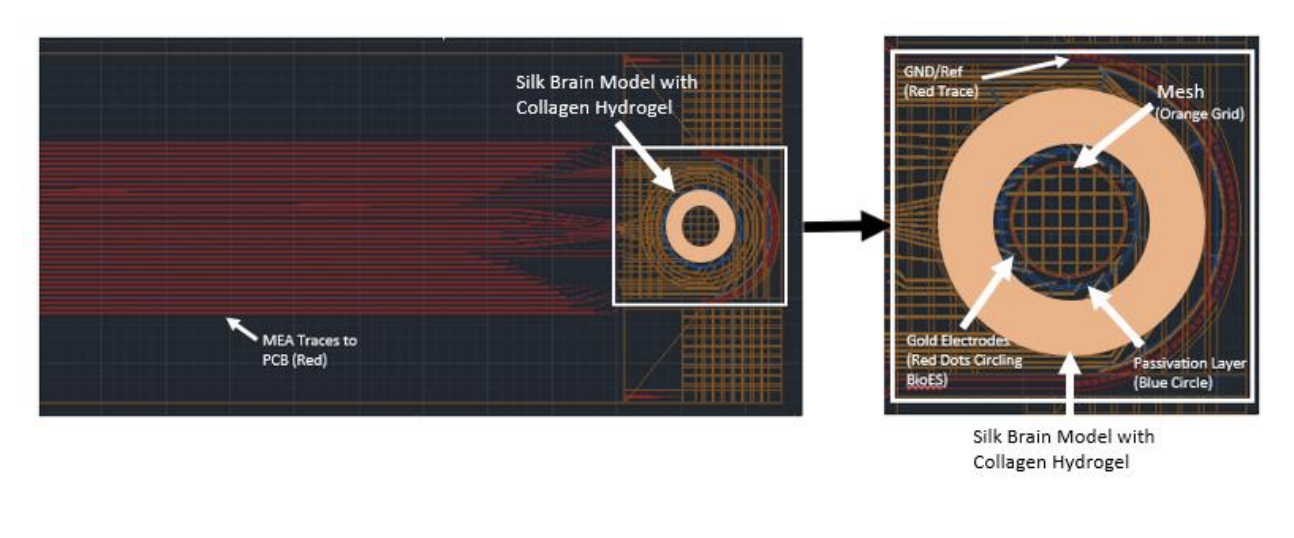
**Silk Scaffolds** were developed using a protocol established by the Kaplan lab - no changes were made. 5 grams worth of silkworm cocoons is cut and boiled in 2 liters of deionized water. They are then rinsed in cold DI water three times before being transferred to a fume hood for overnight drying. Once dry, silk was dissolved in a lithium bromide solution and this mixture was dialyzed over 3 days. After 3 days, the mixture was centrifuged, and the silk concentration was calculated. Water was either added or dried from the solution until the desired 6% concentration was achieved.

**Cell Culturing** was developed using the Kaplan lab protocol with no changes being made. This began with thawing and plating mouse embryonic fibroblasts (MEFs) to secrete growth factors and promote pluripotency in our stem cells. MEFs media was changed every 4 days until they reached 90-95% confluency then hiNSCs were ready to be added. The MEFs were inactivated by adding 500ul of Mitomycin C to the culture plate, leaving it to rest for at least 3 hours, then washing 3x with 1X PBS. HiNSC complete media was added to the plate. HiNSCs were then thawed, centrifuged, and gently added to the same culture plate to not break up the cell colonies. The plate was left to rest for 20 minutes before being incubated. The media was changed every 2 days. All cells were cultured using standard sterile tissue culture technique.

**Cell seeding** was achieved by first coating silk scaffolds in poly-L-orinthine overnight, washing them with PBS, then coating them with laminin for 4-6 hours. These scaffolds were then moved to a 96-well plate with each well homing one scaffold. HiNSCs were lifted from their culture plate and dispensed onto the individual scaffolds using a multichannel pipette at 40ul of cell mixture per scaffold. 150ul of hiNSC media was added and then scaffolds were incubated overnight before adding collagen.

**For adhesion**, two scaffolds will be conjoined using the Kwik-Cast Silicone Elastomer on the top face and bottom face of the device. A diagram is provided below for the anticipated setup (Figure 7).

More experimental techniques and assay methods will be added after a thorough literature review of current methods and protocols.

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**FIGURE 7.** Bioelectronic Device and Scaffold Set Up (CAD Design) - *as adapted from Megan A. Cote*1

**Individual Contributions**

Zainab: Design Flow Chart, Methods, Website, Midsemester PowerPoint, Engineering Design

Enrique: Introduction, Citations, Formatting, Figure 4, Engineering Design, PowerPoint

Diamond: Specific Aims, Unifying Figure, Methods, Abstract, Engineering Design, PowerPoint

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**Appendices: (N/A)**